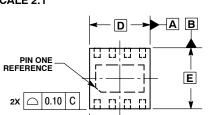
MECHANICAL CASE OUTLINE

2X | \(\to \) 0.10 | C



CDFN8 2x2, 0.5P CASE 505AG **ISSUE O**

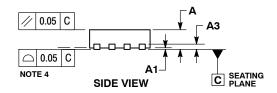
DATE 20 AUG 2012

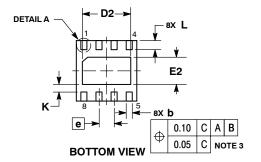


TOP VIEW



DETAIL A ALTERNATE CONSTRUCTION





NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: MILLIMETERS.

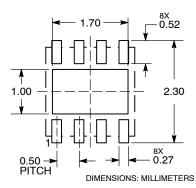
 3. DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.10 AND 0.20MM FROM THE TERMINAL TIP.
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.60	0.70	
A1	0.00	0.05	
A3	0.20 REF		
b	0.15	0.25	
D	2.00 BSC		
D1	1.80 BSC		
D2	1.45	1.70	
Е	2.00 BSC		
E2	0.75	1.00	
е	0.50 BSC		
K	0.15		
L	0.20	0.40	

GENERIC MARKING DIAGRAM*

*No marking due to clear package

RECOMMENDED MOUNTING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	CDFN8, 2X2, 0.5P		PAGE 1 OF 1

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